

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT								
NATURE OF CONVEYANCE:	Corrective Assignment to correct the Assignee's city name from "Saka-shi" to "Sakai-shi" previously recorded on Reel 022266 Frame 0761. Assignor(s) hereby confirms the Assignor's interest.								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>OSAKA PREFECTURE</td><td>11/12/2008</td></tr><tr><td>HOSIDEN CORPORATION</td><td>01/22/2009</td></tr></tbody></table>		Name	Execution Date	OSAKA PREFECTURE	11/12/2008	HOSIDEN CORPORATION	01/22/2009		
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HOSIDEN CORPORATION	01/22/2009								
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<table border="1"><tr><td>Name:</td><td>Osaka Prefecture University Public Corporation</td></tr><tr><td>Street Address:</td><td>1-1 Gakuen-cho, Naka-ku,</td></tr><tr><td>City:</td><td>Sakai-shi Osaka</td></tr><tr><td>State/Country:</td><td>JAPAN</td></tr></table>		Name:	Osaka Prefecture University Public Corporation	Street Address:	1-1 Gakuen-cho, Naka-ku,	City:	Sakai-shi Osaka	State/Country:	JAPAN
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PROPERTY NUMBERS Total: 2									
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Property Type	Number								
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Patent Number:	7128788								
CORRESPONDENCE DATA									
Fax Number: (202)887-0357 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
Phone: 202-659-2930									
Email: rpelayo@kqhpatentlaw.com									
Correspondent Name: Kratz, Quintos & Hanson, LLP									
Address Line 1: 1420 K Street, N.W. Suite 400									
Address Line 4: Washington, DISTRICT OF COLUMBIA 20005									
ATTORNEY DOCKET NUMBER:	021740A								
NAME OF SUBMITTER:	Donald W. Hanson								
Total Attachments: 6 source=021740A Corrective Assignment (Transfer of Patent Right)#page1.tif									

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REEL: 022399 FRAME: 0132

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PATENT

Address Line 4: Washington, DISTRICT OF COLUMBIA 20005	
ATTORNEY DOCKET NUMBER:	021740A
NAME OF SUBMITTER:	Donald W. Hanson
Signature:	/DWH/
Date:	02/18/2009
Total Attachments: 3 source=021740A Assignment (Transfer of Patent Right)#page1.tif source=021740A Assignment (Transfer of Patent Right)#page2.tif source=021740A Assignment (Transfer of Patent Right)#page3.tif	
RECEIPT INFORMATION EPAS ID: PAT801142 Receipt Date: 02/18/2009 Fee Amount: \$80	

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PATENT



UNITED STATES PATENT AND TRADEMARK OFFICE

021740A

UNDER SECRETARY OF COMMERCE FOR INTELLECTUAL PROPERTY AND
DIRECTOR OF THE UNITED STATES PATENT AND TRADEMARK OFFICE



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FEBRUARY 18, 2009

PTAS

KRATZ, QUINTOS & HANSON, LLP
1420 K STREET, N.W. SUITE 400
WASHINGTON, DC 20005

UNITED STATES PATENT AND TRADEMARK OFFICE
NOTICE OF RECORDATION OF ASSIGNMENT DOCUMENT

THE ENCLOSED DOCUMENT HAS BEEN RECORDED BY THE ASSIGNMENT DIVISION OF THE U.S. PATENT AND TRADEMARK OFFICE. A COMPLETE MICROFILM COPY IS AVAILABLE AT THE ASSIGNMENT SEARCH ROOM ON THE REEL AND FRAME NUMBER REFERENCED BELOW.

PLEASE REVIEW ALL INFORMATION CONTAINED ON THIS NOTICE. THE INFORMATION CONTAINED ON THIS RECORDATION NOTICE REFLECTS THE DATA PRESENT IN THE PATENT AND TRADEMARK ASSIGNMENT SYSTEM. IF YOU SHOULD FIND ANY ERRORS OR HAVE QUESTIONS CONCERNING THIS NOTICE, YOU MAY CONTACT THE EMPLOYEE WHOSE NAME APPEARS ON THIS NOTICE AT 571-272-3350. PLEASE SEND REQUEST FOR CORRECTION TO: U.S. PATENT AND TRADEMARK OFFICE, MAIL STOP: ASSIGNMENT SERVICES BRANCH, P.O. BOX 1450, ALEXANDRIA, VA 22313.

RECORDATION DATE: 02/18/2009

REEL/FRAME: 022266/0761

NUMBER OF PAGES: 4

BRIEF: ASSIGNMENT OF ASSIGNOR'S INTEREST (SEE DOCUMENT FOR DETAILS).
DOCKET NUMBER: 021740A

ASSIGNOR:

OSAKA PREFECTURE

DOC DATE: 11/12/2008

ASSIGNOR:

HOSIDEN CORPORATION

DOC DATE: 01/22/2009

ASSIGNEE:

OSAKA PREFECTURE UNIVERSITY PUBLIC
CORPORATION
1-1 GAKUEN-CHO, NAKA-KU,
SAKA-SHI OSAKA, JAPAN

SERIAL NUMBER: 10802806

FILING DATE: 03/18/2004

PATENT NUMBER: 7128788

ISSUE DATE: 10/31/2006

TITLE: MANUFACTURING APPARATUS FOR BURIED INSULATING LAYER-TYPE
SEMICONDUCTOR SILICON CARBIDE SUBSTRATE

DOCKETED

DATE

PATENT

2/19/09

KRATZ, QUINTOS & HANSON, LLP

U.S. ASSIGNMENT

WHEREAS, OSAKA PREFECTURE (hereinafter referred to as OSAKA), a governmental entity of Japan, having an address of business at 2-1-22, Otemae, Chuo-ku, Osaka-shi, Osaka, Japan, and HOSIDEN CORPORATION (hereinafter referred to as HOSIDEN), a Japanese corporation, of 4-33, Kitakyuhoji 1-chome, Yao-shi, Osaka, Japan, jointly own the entire right, title and interest in and to any and all improvements in the following:

(1) MANUFACTURING METHOD FOR BURIED INSULATING LAYER-TYPE SEMICONDUCTOR SILICON CARBIDE SUBSTRATE as described and claimed in U.S. Patent No. 7,084,049 issued August 1, 2006, by virtue of an assignment recorded in the U.S. Patent and Trademark Office in reel/frame 013709/0610;

(2) MANUFACTURING APPARATUS FOR BURIED INSULATING LAYER-TYPE SEMICONDUCTOR SILICON CARBIDE SUBSTRATE as described and claimed in U.S. Patent No. 7,128,788 issued October 31, 2006, by virtue of an assignment recorded in the U.S. Patent and Trademark Office in reel/frame 013709/0610-0613.

WHEREAS, OSAKA and HOSIDEN (hereinafter ASSIGNORS in this Assignment,) wish to assign and transfer to Osaka Prefecture University Public Corporation, a corporation of Japan, having an office and place of business at 1-1 Gakuen-cho, Naka-ku, Sakai-shi Osaka, Japan, hereinafter ASSIGNEE in this Assignment, and said ASSIGNEE wishes to acquire the entire right, title and interest in and to U.S. Patent Nos. 7,084,049; and 7,128,788.

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that in consideration of the payment by ASSIGNEE to ASSIGNORS of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt whereof is hereby acknowledged, ASSIGNORS hereby sell, assign, and transfer to ASSIGNEE the full and exclusive right, title and interest to said improvements and all three said Letters Patent of the United States granted therefore and any continuation, divisional, renewal, substitute, or reissue thereof for the full term or terms for which the same may be granted.

ASSIGNORS hereby covenant that no assignment, sale, agreement, or encumbrance has been or will be made or entered into which would conflict with this Assignment and sale;

ASSIGNORS further covenant that it will, upon request by the ASSIGNEE promptly provide all pertinent facts and documents relating to said invention and said Letters Patent as may be known and accessible to ASSIGNORS and will testify as to the same in any interference or litigation relation thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments, or affidavits required to apply for, obtain, maintain, and enforce said improvements and said Letters patent which may be necessary or desirable to carry out the purposes hereof.

IN WITNESS WHEREOF, I have hereunto set hand and seal:

OSAKA PREFECTURE

Date: Nov, 12, 2008

Toru Hashimoto

By: Toru Hashimoto

Title: Governor of Osaka Prefecture

HOSIDEN CORPORATION

Date: Jan. 22, 2009

[Signature]

By: Kenji Furuhashi

Title: President and CEO